

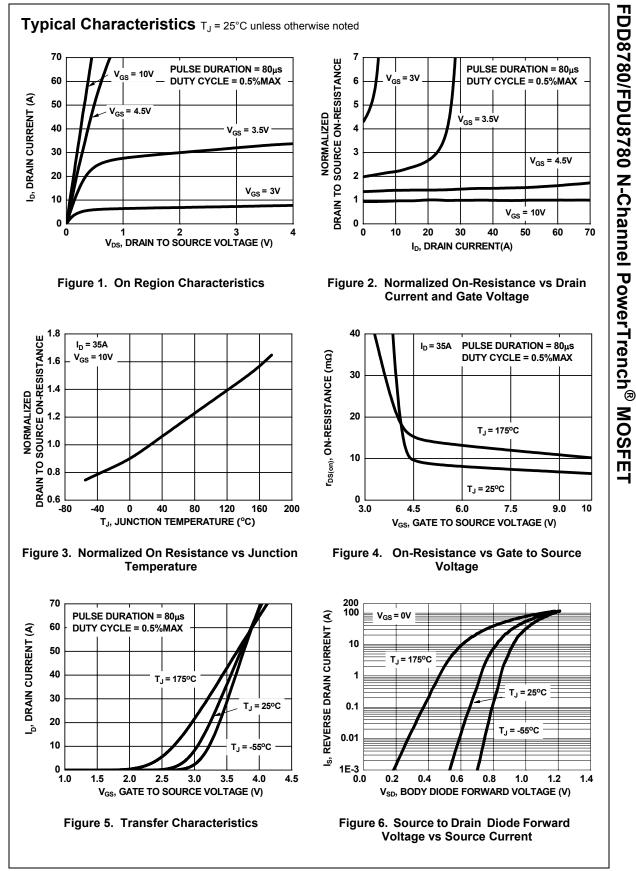
Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage		25	V	
V <sub>GS</sub>	Gate to Source Voltage		±20	V	
I <sub>D</sub>	Drain Current -Continuous (Package Limited)		35		
	-Continuous (Die Limited)		60	Α	
	-Pulsed	(Note 1)	224		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	73	mJ	
PD	Power Dissipation		50	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to 175	°C	

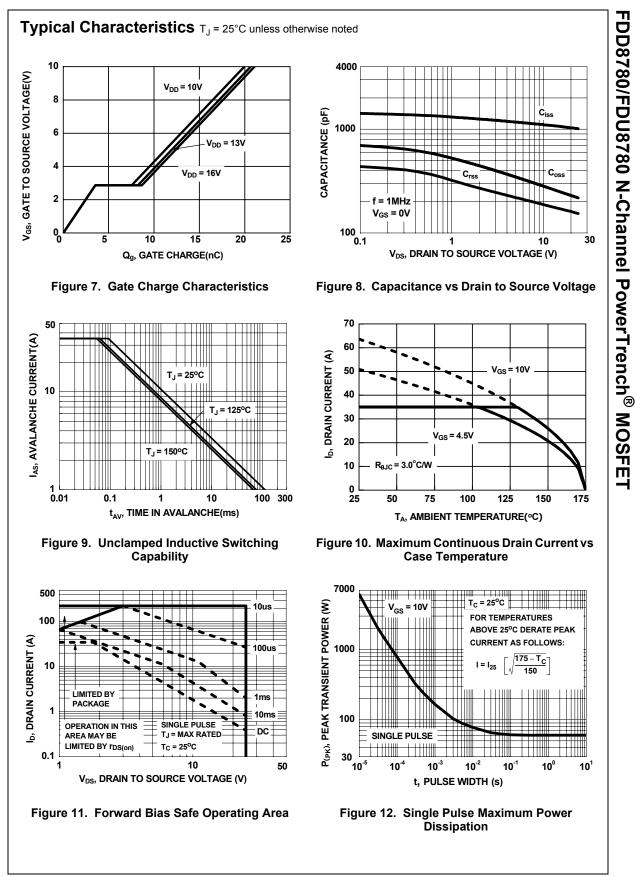
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case TO-252, TO-251	3.0	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient TO-252, TO-251	100	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient TO-252,1in <sup>2</sup> copper pad area	52	°C/W

## Package Marking and Ordering Information

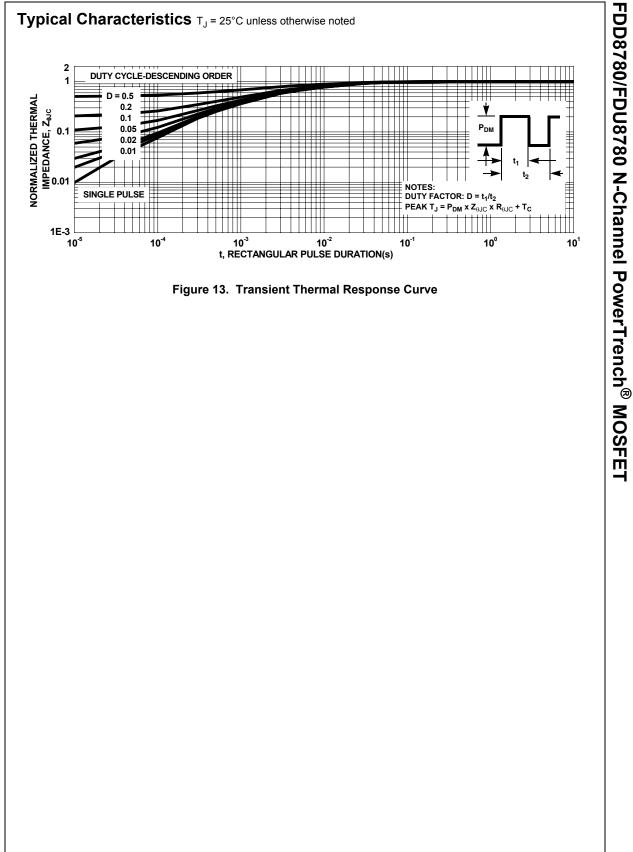
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8780	FDD8780	TO-252AA	13"	16mm	2500 units
FDU8780	FDU8780	TO-251AA	N/A(Tube)	N/A	75 units
FDU8780	FDU8780_F071	TO-251AA	N/A(Tube)	N/A	75 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	octeristics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	25			V	
$\frac{\Delta B_{VDSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu A$ , referenced to $25^{\circ}C$		12		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20V,$ $V_{GS} = 0V$ $T_J = 150^{\circ}C$			1 250	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	1.2	1.8	2.5	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250µA, referenced to 25°C		-6.3		mV/°C	
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A		6.5	8.5	mΩ	
	Drain to Source On Resistance	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 35A		9.1	12.0		
r <sub>DS(on)</sub>	Dialo lo Source Un Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 35A T <sub>J</sub> = 175°C		10.4	15.0	- 11152	
	Characteristics			1	1	I	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 13V, V <sub>GS</sub> = 0V,		1080	1440	pF	
C <sub>oss</sub>	Output Capacitance	f = 1MHz		265	355	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			180	270	pF	
Rg	Gate Resistance	f = 1MHz		0.9		Ω	
Switching	g Characteristics			1	1	1	
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 13V, I <sub>D</sub> = 35A		7	14	ns	
t <sub>r</sub>	Rise Time	$V_{GS} = 10V, R_{GS} = 17\Omega$		9	18	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time			43	69	ns	
t <sub>f</sub>	Fall Time			24	38	ns	
Qg	Total Gate Charge	$ \begin{array}{c} V_{GS} = 0V \text{ to } 10V \\ V_{GS} = 0V \text{ to } 5V \\ I_D = 35A \\ I_q = 1.0\text{mA} \end{array} $		21	29	nC	
Qg	Total Gate Charge			11.2	16	nC	
Q <sub>gs</sub>	Gate to Source Gate Charge			3.5		nC	
Q <sub>gd</sub>	Gate to Drain "Miller"Charge	5		4.7		nC	
Drain Sau	urce Diode Characteristics						
Drain-Sol	Source to Drain Diade Converd Vallage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 35A		0.92	1.25	- V	
		V <sub>GS</sub> = 0V, I <sub>S</sub> = 15A		0.84	1.0		
V <sub>SD</sub>	Source to Drain Diode Forward Voltage					1	
	Reverse Recovery Time	$I_{\rm F}$ = 35A, di/dt = 100A/µs		28	42	ns	





FDD8780/FDU8780 Rev. 1.1



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